## Supporting Information for "Tunable and rapid self-assembly of block copolymers using mixed solvent vapors"

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**Fig. S1** Morphology transition from HPL to lamella structures for SV42 BCP depending on  $V_{DMF}/V_{TOL}$  ratio. (a)  $V_{DMF}/V_{TOL} = 0.81$ , (b) 1.0, (c) 1.4, (d) 2.0. Lamellar morphology began to appear at  $V_{DMF}/V_{TOL} = 1.0$ . As the fraction of DMF increased, the effective volume fraction of P2VP ( $f_{P2VP}^{eff}$ ) increased in proportion to  $V_{DMF}/V_{TOL}$  ratio, showing the complete morphological change from HPL ( $V_{DMF}/V_{TOL} = 0.81$ ) to lamellar structure at  $V_{DMF}/V_{TOL} = 2.0$ .



Fig. S2 Self-assembled metal-oxide line and HPL patterns *via* various metal ion incorporation process followed by  $O_2$  plasma treatment at  $V_{DMF}/V_{TOL} = 0$  (pure toluene) and 0.71, respectively. (a) CoO<sub>x</sub>, and (b) FeO<sub>x</sub>.



**Fig. S3** Time-evolution of the self-assembled SV42 BCP *via* pure toluene treatment. (a) 10 min, (b) 20 min, (c) 30 min, and (d) 90 min.



Fig. S4 Rapidly formed 12-nm line pattern of SV42 BCP over the large area using mixed solvents of pyridine and toluene ( $V_{PYR}/V_{TOL} = 1$ ).



**Fig. S5** Rapid 6-nm-line pattern-formation of SV34 BCP depending on the  $V_{PYR}/V_{TOL}$  ratio for 5 min. (a)  $V_{PYR}/V_{TOL} = 0.2$ , (b) 0.5, (c) 2.0.



Fig. S6 Rapidly formed 6-nm line pattern of SV34 BCP over the large area using mixed solvents of pyridine and toluene ( $V_{PYR}/V_{TOL} = 0.2$ ) for 5 min.



**Fig. S7** The comparison of the self-assembled nanostructures of lines within the trench and holes on mesa region. (a) Line and hole binary structures of SV42 BCP with 1.2 wt% formed on the with Si substrates with line and space trenches, (b) Magnified SEM image of (a), (c) Schematic diagram for the cross-sectional SEM image of (a & b).